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Paper Submission: <http://edas.info/N24399> or Login
EDAS at <http://edas.info/> by selecting "CyberC 2018".
Electronic submission to Papers@cyberc.org with a title
of "CyberC 2018 Submission" is also accepted.

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CyberC Sponsors: [IEEE Communication Society](#), [IEEE
Big Data Initiative](#), [IEEE SDN \(Software Defined
Networks\)](#), [IEEE China](#), [IEEE Communications Society
\(ComSoc\)](#) [Technical Committee on Big Data \(TCBD\)](#).

EVENTS

Emerging Technology Summit: October 18, 2018.

Keynotes (Partial List):

Alok Srivastava, Lead Architect, Microsoft Corp., USA
Chih-Lin I, Chief Scientist, Wireless Technologies,
China Mobile Research Institute
Feifei Gao, Tsing Hua University, Beijing, China
Yang Yang, Shanghai Institute of Microsystem and
Information Technology, Chinese Academy of Sciences

PRELIMINARY CALL FOR PAPERS

CyberC 2018

The 10th International Conference on Cyber-Enabled Distributed Computing and Knowledge Discovery

Zhengzhou, China, October 18 - 20, 2018

www.Cyberc.org

Technically Co-sponsored by IEEE, IEEE Communication Society, IEEE Big Data Initiative, IEEE
SDN (Software Defined Networks) Initiative, IEEE China, IEEE Communications Society (ComSoc)
Technical Committee on Big Data (TCBD).

Sponsored by Zhengzhou University, Tech Mahindra, Huawei, AT&T, InfoBeyond, IEEE Big
Data Initiative, IEEE SDN Initiative

The Proceedings will be published by IEEE (EI & Explore)

Scopes: CyberC promotes in-depth exploration of the most recent research and developments in the field of big data, distributed computing, clouds, cyber security, pervasive computing, mobile computing, Internet of Things, and other cyber-based technologies. Scientists, engineers, and students in the areas are encouraged to participate. CyberC also welcomes the participation of the industry to showcase and commercialize their relevant technology and products.

Zhengzhou: The 10th CyberC will be held in Zhengzhou, China.

Summits: CyberC 2018 co-hosts **Emerging Technology Summit (AI, Big Data, 5G)** forum that emphasizes innovative and state-of-art R&D, industry products, specifications, showcases, tutorial, technical transitions, and markets.

Tour: One or two-day tours will be scheduled for local historical sites ([Shaolin temple](#) (Chinese martial arts, a.k.a., [Shaolin Kung Fu](#)), [Longmen Grottoes](#), [Luoyang](#), [Yellow river](#)).

Topics: The topics of interests include, but not limited to:

- Big Data, big data analytics, decision-making
- AI and Applications
- Cyber, Internet of things, localization, and distributed computing
- 5G, wireless networks, RF, wireless communications, and mobile computing
- Cyber surveillance and cyber physical systems
- Cloud Computing and mobile clouds

- Wireless Communications
- Cyber security and privacy, cyber trust, cyber agility, and cyber assurance

Co-hosted Workshops: CyberC 2018 incorporates four workshops:

- **Big Data 2018:** The 5th International Workshop on Big Data
- **Security 2018:** The 6th workshop on Cyber Security and Privacy
- **AIL 2018:** The 1st workshop on Artificial Intelligence and Learning
- **IOT 2018:** The 2st International Workshop on Internet of Things and Future Communication Technologies
- **Smart Sensor Network:** The 6th workshop on Smart Cities Enabling Technologies.

INFORMATION FOR AUTHORS

The CyberC 2018 Proceedings will be published by IEEE CPS. **Full papers** for CyberC 2018 must not exceed 10 pages of IEEE 2-column format, while **short papers** must not exceed 4 pages. Please visit the conference web site at <http://www.cyberc.org> for precise formatting and submission instructions.

IMPORTANT DATES

Submission deadline for full (10-page) and/or short (4-page) papers: **Apr. 15, 2018**
Notification of acceptance: **July 15, 2018**
Camera-ready deadline: **August 15, 2018**

AUTHOR CONTACTS

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CyberC 2017 Data: Number of submissions: 293, Number of full papers: 57, Number of Short Papers: 37, Number of Reviewers: 150, Number of Attendees: 145, Number of Sessions: 10, Number of Keynotes: 13, Scholars in CyberC QQ group: 221, Scholars in Big Data QQ group: 259.

CyberC QQ Group: 426380304; **Big Data Group:** 208385582

Emerging Technology Summit Site: <http://www.cyberc.org/bigdata/>

Summit Invited Speakers: TBD

CyberC 2009 - 2017 Proceeding: [EI](#), [IEEE Xplore](#)